

# PARA LIGHT ELECTRONICS CO., LTD.

11F., No. 8, Jiankang Rd., Zhonghe Dist., New Taipei City 235, Taiwan Tel: 886-2-2225-3733 E-mail: para@para.com.tw

Fax: 886-2-2225-4800 http:// www.paralighttaiwan.com



# PART NO.: L-H513028B

REV: <u>A / 1</u>

CUSTOMER'S APPROVAL :

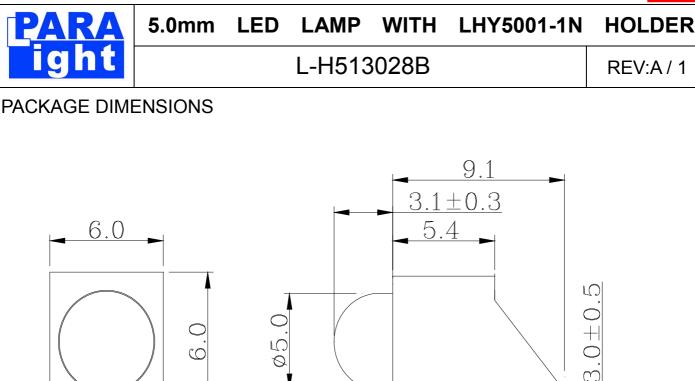
DRAWING NO. : DS-60-17-0065

DCC :

DATE: 2017-07-20

Page: 1





Note:

2.54

1.All Dimensions are in millimeters.

0.5

5.05

2.Tolerance is ±0.25mm(0.010 ")Unless otherwise specified.

3.Protruded resin under flange is 1.5mm(0.059 ") max.

4.Lead spacing is measured where the leads emerge from the package.

5. Specification are subject to change without notice

6.The lamps have sharp and hard points that may injure human eyes or fingers etc., so please pay enough care in the handling.

7. A= L503LRD

DATE : 2017-07-20



#### 5.0mm LED LAMP WITH LHY5001-1N HOLDER

# L-H513028B

REV:A/1

#### FEATURES

\* 5.0 mm DIA LED LAMP

\* LOW POWER CONSUMPTION.

- \* I.C. COMPATIBLE.
- \* LONG LIFE SOLID STATE RELIABILITY

\* PB FREE PRODUCTS(Compliant with EU's RoHS.)

#### CHIP MATERIALS

- \* Dice Material : GaP
- \* Light Color : Red
- \* Lens Color : Red Diffused

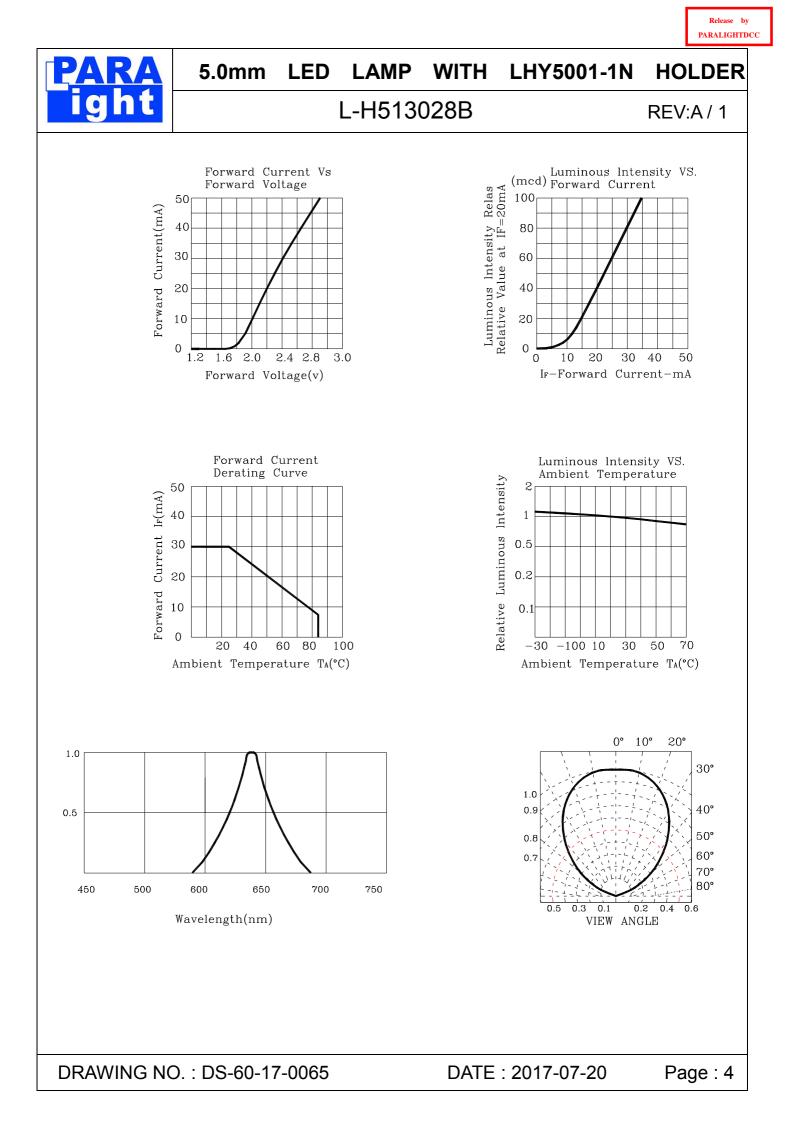
ABSOLUTE MAXIMUM RATING : ( Ta = 25°C )

· · · · · · · · · · · · · · · · · · ·			
PARAMETER	Red	UNIT	
Power Dissipation	78		
Reverse Voltage	5	V	
Average Forward Current(Duty=0.1,1KHZ) 30			
Peak Forward Current Per Chip (Duty=0.1,1KHz)	1KHz) 120 mA		
Derating Linear From 25 $^\circ\!\mathrm{C}$	0.4	mA/°C	
Operating Temperature Range	-25℃ to 85℃		
Storage Temperature Range	-40°℃ to 85°℃		
	Power Dissipation Reverse Voltage Average Forward Current(Duty=0.1,1KHZ) Peak Forward Current Per Chip (Duty=0.1,1KHz) Derating Linear From 25°C Operating Temperature Range	Power Dissipation78Reverse Voltage5Average Forward Current(Duty=0.1,1KHZ)30Peak Forward Current Per Chip (Duty=0.1,1KHz)120Derating Linear From 25°C0.4Operating Temperature Range-25°C to 8	

#### ELECTRO-OPTICAL CHARACTERISTICS : ( Ta = 25°C )

SYMBOL	DESCRIPTION	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
Vf	Forward Voltage	IF=20mA	Red		1.8	2.6	V
IR	Reverse Current	VR=5 V	Red			100	$\mu A$
λD	Dominant Wavelength	IF=20mA	Red		640		nm
Δλ	Spectral Line Half-Width	IF=20mA	Red		30		nm
2 0 1/2	Half Intensity Angle	IF=20mA	Red		90		deg
lv	Luminous Intensity	IF=20mA	Red		40		mcd

DRAWING NO. : DS-60-17-0065





# 5.0mm LED LAMP WITH LHY5001-1N HOLDER

# L-H513028B

REV:A/1

## Label Explanation



N'W : Net Weight Bin Code List:





### 5.0mm LED LAMP WITH LHY5001-1N HOLDER

# L-H513028B

REV:A/1

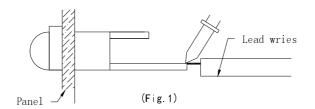
#### •SOLDERING

 $\circ$ 

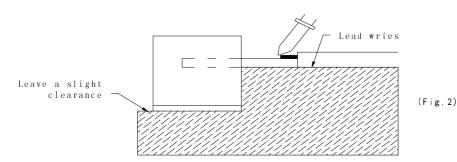
0

SOLDERING CONDITIONS	REMARK
	<ul> <li>Solder no closer than 3mm</li> </ul>
Bath temperature: 260℃	from the base of the package
Immersion time: with 5 sec	<ul> <li>Using soldering flux," RESIN FLUX"</li> </ul>
	is recommended.
	• During soldering, take care not to
	press the tip of iron against the
Soldering iron: 30W or smaller	lead.
Temperature at tip of iron: 300 $^\circ\!\!\!\!{}^\circ\!\!\!{}^\circ$ or lower	(To prevent heat from being
Soldering time: within 5 sec.	transferred directly to the lead, hold
	the lead with a pair of tweezers
	while soldering
	Bath temperature: 260℃ Immersion time: with 5 sec Soldering iron: 30W or smaller Temperature at tip of iron: 300℃ or lower

 When soldering the lead of LED in a condition that the package is fixed with a panel (See Fig.1), be careful not to stress the leads with iron tip.



2) When soldering wire to the lead, work with a Fig (See Fig.2) to avoid stressing the package.



Regarding solution in the tinning oven for product-tinning, compound sub-solution made of tin & copper and sliver is proposed with the temperature of Celsius 260. The proportion of the alloyed solution is tin 95.5: copper 3.5: silver 0.5 by percentage. The time of tinning is constantly 3 seconds.





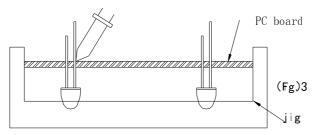
 $\circ$ 

#### 5.0mm LED LAMP WITH LHY5001-1N HOLDER

# L-H513028B

#### REV:A/1

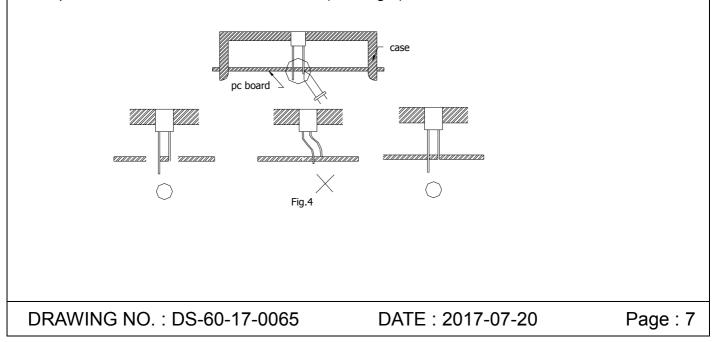
3) Similarly, when a jig is used to solder the LED to PC board, take care as much as possible to avoid steering the leads (See Fig.3).

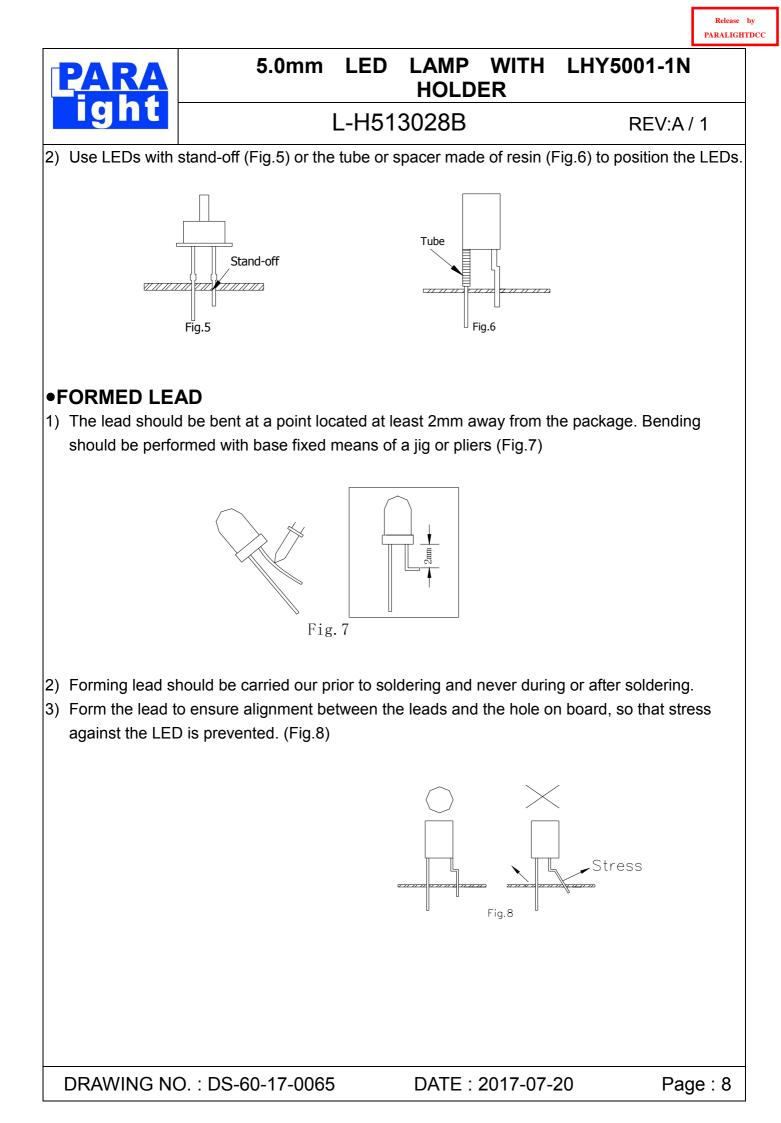


- 4) Repositioning after soldering should be avoided as much as possible. If inevitable, be sure to preserve the soldering conditions with irons stated above: select a best-suited method that assures the least stress to the LED.
- Lead cutting after soldering should be performed only after the LED temperature has returned to normal temperature.

#### •LED MOUNTING METHOD

1) When mounting the LED by using a case, as shown Fig.4, ensure that the mounting holds on the PC board match the pitch of the leads correctly-tolerance of dimensions of the respective components including the LED should be taken into account especially when designing the case, PC board, etc. to prevent pitch misalignment between the leads and board holes, the diameter of the board holes should be slightly larger than the size of the lead. Alternatively, the shape of the holes should be made oval. (See Fig.4)







### 5.0mm LED LAMP WITH LHY5001-1N HOLDER

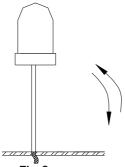
# L-H513028B

REV:A/1

#### •LEAD STRENGTH

1) Bend strength

Do not bend the lead more than twice. (Fig.9)





Tensile strength (@Room Temperature)
 If the force is 1kg or less, there will be no problem. (Fig.10)



### •HANDLING PRECAUTIONS

Although rigid against vibration, the LEDs may damaged or scratched if dropped. So take care when handling.

### •CHEMICAL RESISTANCE

- 1) Avoid exposure to chemicals as it may attack the LED surface and cause discoloration.
- 2) When washing is required, refer to the following table for the proper chemical to be sued.
- (Immersion time: within 3 minutes at room temperature.)

SOLVENT	ADAPTABILITY		
Freon TE	$\odot$		
Chlorothene	$\times$		
Isopropyl Alcohol	$\odot$		
Thinner	$\times$		
Acetone	$\times$		
Trichloroethylene	×		

 $\odot$ --Usable  $\times$ --Do not use.

NOTE: Influences of ultrasonic cleaning of the LED resin body differ depending on such factors as the oscillator output, size of the PC board and the way in which the LED is mounted. Therefore, ultrasonic cleaning should only be performed after confirming there is no problem by



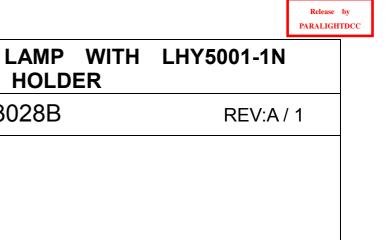
# 5.0 mm LED LAMP WITH H506 HOLDER

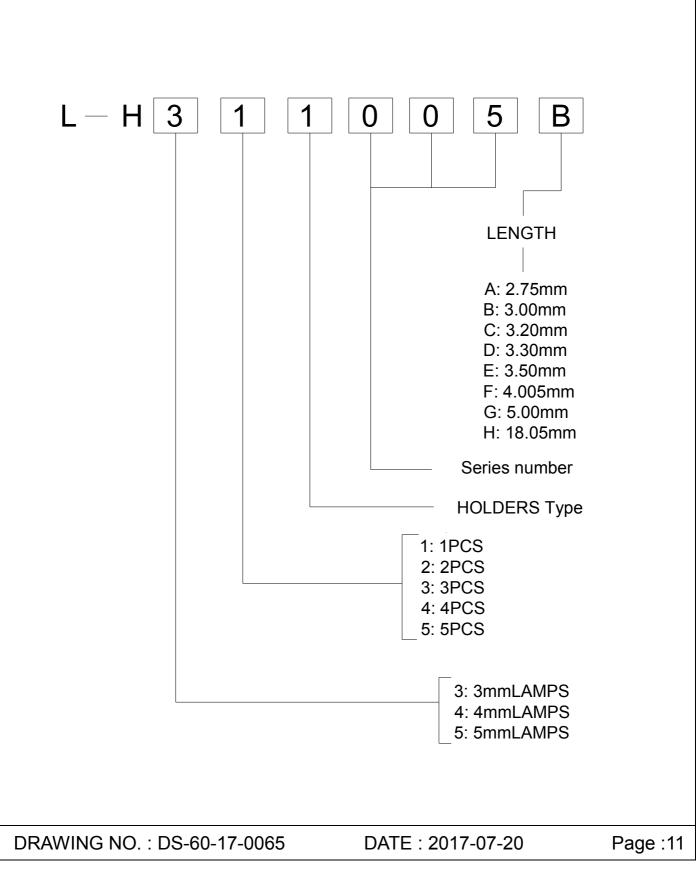
# L-H513028B

REV:A/1

#### •OTHERS

- 1) Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
- 2) Flashing lights have been known to cause discomfort in people; you can prevent this by taking precautions during use. Also, people should be cautious when using equipment that has had LEDs incorporated into it.
- 3) The LEDs described in this brochure are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult PARA's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, aerospace, submersible repeaters, nuclear reactor control systems, automobiles, traffic control equipment, life support systems and safety devices).
- 4) User shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from PARA. When defective LEDs are found, the User shall inform PARA directly before disassembling or analysis.
- 5) The formal specifications must be exchanged and signed by both parties before large volume purchase begins.
- 6) The appearance and specifications of the product may be modified for improvement without notice.





5.0mm LED

HOLDER

L-H513028B

P

RA

ht



